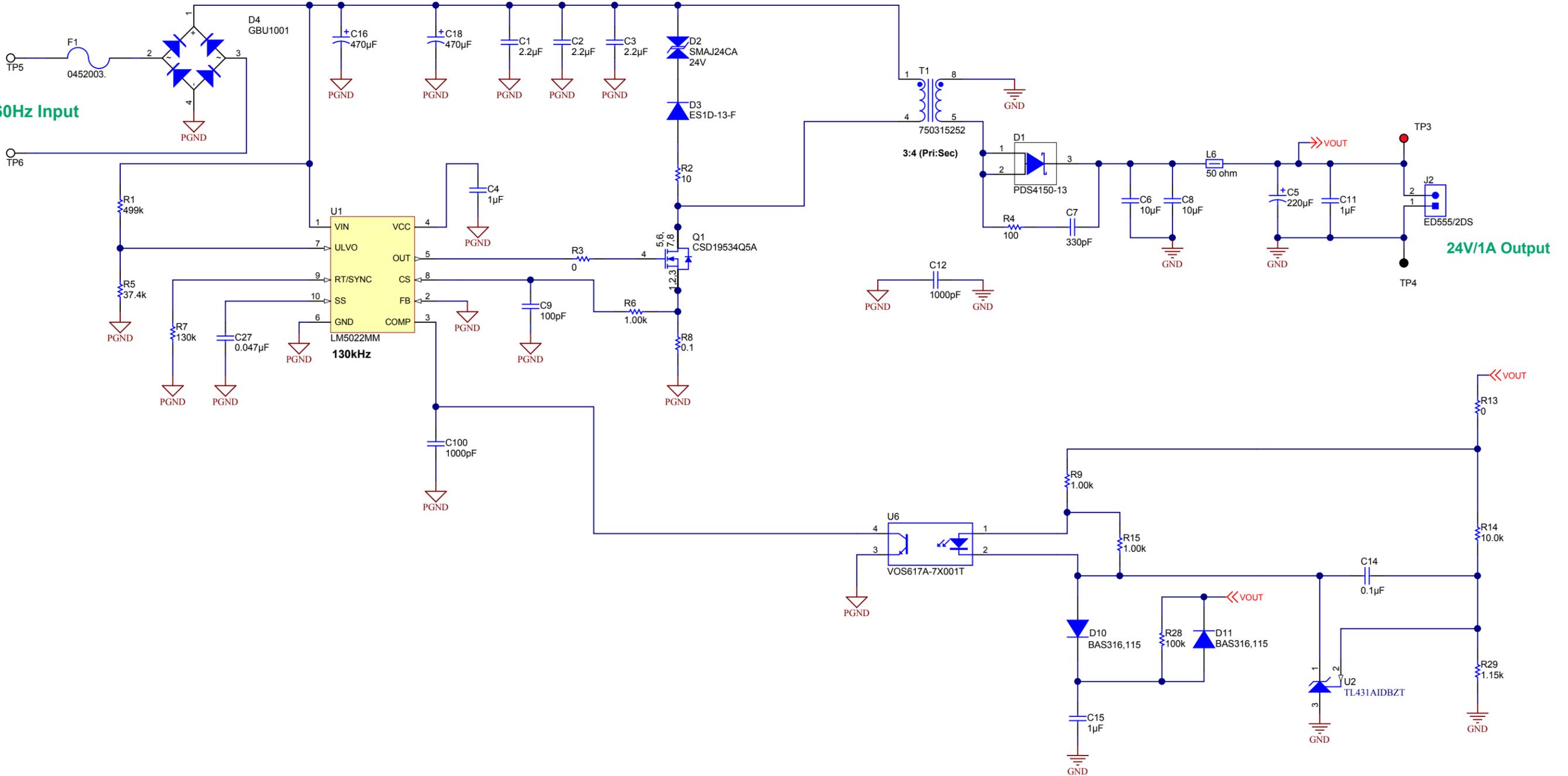


Assembly Notes:

1. Built on PMP10856 Rev A PCB.
2. C16 and C18 do not match footprint on PCB.

18-30VAC 60Hz Input



24V/1A Output

PCB Number: PMP10856
PCB Rev: A

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Orderable: N/A	Designed for: Project Title: 18-30VAC Input, 24V/1A Flyback	Mod. Date: 3/24/2015
TID #: ChangeMe!	Number: PMP10856	Rev: B
SVN Rev: Version control disabled	File: PMP10856_REV.B.SchDoc	Sheet: 2 of 3
Drawn By: B King	Contact: http://www.ti.com/support	Size: B



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